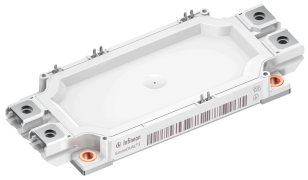
Final datasheet

EconoDUAL™3 module with Trench/Fieldstop IGBT4 and emitter controlled diode and NTC



Features

- Electrical features
  - V_{CES} = 1700 V
  - $I_{C\ nom}$ = 225 A / I_{CRM} = 450 A
  - Low $V_{CE,sat}$
  - $T_{vj,op}$ = 150°C
  - Suitable Infineon gate drivers can be found under https://www.infineon.com/gdfinder
- Mechanical features
  - Standard housing

Potential applications

- Motor drives
- Servo drives
- UPS systems
- Wind turbines

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

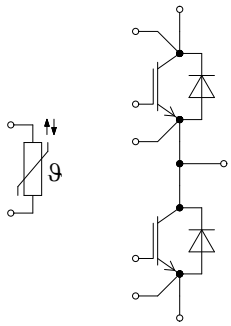


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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, f = 50 Hz, *t* = 1 min	3.4	kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, f = 50 Hz, *t* = 1 min	3.4	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	$d_{Creep\ nom}$	terminal to baseplate, nom.	> 15	mm
Creepage distance	$d_{Creep\ min}$	terminal to baseplate, min.	14.7	mm
Creepage distance	$d_{Creep\ nom}$	terminal to terminal, nom.	> 19.3	mm
Creepage distance	$d_{Creep\ min}$	terminal to terminal, min.	19.3	mm
Clearance	$d_{Clear\ nom}$	terminal to baseplate, nom.	> 12.5	mm
Clearance	$d_{Clear\ min}$	terminal to baseplate, min.	12.5	mm
Clearance	$d_{Clear\ nom}$	terminal to terminal, nom.	> 10	mm
Clearance	$d_{Clear\ min}$	terminal to terminal, min.	9.6	mm
Comparative tracking index	*CTI*		> 200	
Relative thermal index (electrical)	*RTI*	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Stray inductance module	L_{sCE}				20		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	T_C = 25 °C, per switch			1		mΩ
Storage temperature	T_{stg}			-40		125	°C
Mounting torque for module mounting	*M*	- Mounting according to valid application note	M5, Screw	3		6	Nm
Terminal connection torque	*M*	- Mounting according to valid application note	M6, Screw	3		6	Nm
Weight	*G*				345		g

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		T_{vj} = 25 °C	1700	V
Continuous DC collector current	I_{CDC}	$T_{vj\,max}$ = 175 °C	T_C = 100 °C	225	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\,op}$		450	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\,sat}$	I_C = 225 A, V_{GE} = 15 V	T_{vj} = 25 °C		1.95	2.30	V
			T_{vj} = 125 °C		2.35		
			T_{vj} = 150 °C		2.45		
Gate threshold voltage	V_{GEth}	I_C = 9 mA, V_{CE} = V_{GE}, T_{vj} = 25 °C		5.20	5.80	6.40	V
Gate charge	Q_G	V_{GE} = ±15 V, T_{vj} = 25 °C			2.35		µC
Internal gate resistor	R_{Gint}	T_{vj} = 25 °C			2.8		Ω
Input capacitance	C_{ies}	f = 1000 kHz, T_{vj} = 25 °C, V_{CE} = 25 V, V_{GE} = 0 V			18.5		nF
Reverse transfer capacitance	C_{res}	f = 1000 kHz, T_{vj} = 25 °C, V_{CE} = 25 V, V_{GE} = 0 V			0.6		nF
Collector-emitter cut-off current	I_{CES}	V_{CE} = 1700 V, V_{GE} = 0 V	T_{vj} = 25 °C			3	mA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25 °C				400	nA
Turn-on delay time (inductive load)	t_{don}	I_C = 225 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Gon} = 3.3 Ω	T_{vj} = 25 °C		0.220		µs
			T_{vj} = 125 °C		0.250		
			T_{vj} = 150 °C		0.260		
Rise time (inductive load)	t_r	I_C = 225 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Gon} = 3.3 Ω	T_{vj} = 25 °C		0.080		µs
			T_{vj} = 125 °C		0.085		
			T_{vj} = 150 °C		0.090		
Turn-off delay time (inductive load)	t_{doff}	I_C = 225 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Goff} = 6.2 Ω	T_{vj} = 25 °C		0.690		µs
			T_{vj} = 125 °C		0.840		
			T_{vj} = 150 °C		0.880		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Fall time (inductive load)	t_f	I_C = 225 A, V_{CC} = 900 V, V_{GE} = ±15 V, R_{Goff} = 6.2 Ω	T_{vj} = 25 °C		0.280		µs
			T_{vj} = 125 °C		0.540		
			T_{vj} = 150 °C		0.620		
Turn-on energy loss per pulse	E_{on}	I_C = 225 A, V_{CC} = 900 V, L_σ = 35 nH, V_{GE} = ±15 V, R_{Gon} = 3.3 Ω, di/dt = 3100 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		51		mJ
			T_{vj} = 125 °C		67.5		
			T_{vj} = 150 °C		72		
Turn-off energy loss per pulse	E_{off}	I_C = 225 A, V_{CC} = 900 V, L_σ = 35 nH, V_{GE} = ±15 V, R_{Goff} = 6.2 Ω, dv/dt = 3000 V/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		45.5		mJ
			T_{vj} = 125 °C		73.5		
			T_{vj} = 150 °C		83.5		
SC data	I_{SC}	V_{GE} ≤ 15 V, V_{CC} = 1000 V, V_{CEmax}=V_{CES}-L_{sCE}*di/dt	t_P ≤ 10 µs, T_{vj}=150 °C		1100		A
Thermal resistance, junction to case	R_{thJC}	per IGBT				0.099	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, λ_{grease} = 1 W/(m·K)			0.029		K/W
Temperature under switching conditions	$T_{vj\,op}$			-40		150	°C

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		T_{vj} = 25 °C	1700	V
Continuous DC forward current	I_F			225	A
Repetitive peak forward current	I_{FRM}	t_P = 1 ms		450	A
I^2t - value	I^2t	t_P = 10 ms, V_R = 0 V	T_{vj} = 125 °C	8300	A^2s

Table 6 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Forward voltage	V_F	I_F = 225 A, V_{GE} = 0 V	T_{vj} = 25 °C		1.80	2.20	V
			T_{vj} = 125 °C		1.90		
			T_{vj} = 150 °C		1.95		

(table continues...)

Table 6 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Peak reverse recovery current	I_{RM}	V_{CC} = 900 V, I_F = 225 A, V_{GE} = -15 V, -di$_F$/dt = 3100 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		320		A
			T_{vj} = 125 °C		375		
			T_{vj} = 150 °C		385		
Recovered charge	Q_r	V_{CC} = 900 V, I_F = 225 A, V_{GE} = -15 V, -di$_F$/dt = 3100 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		57		µC
			T_{vj} = 125 °C		97		
			T_{vj} = 150 °C		110		
Reverse recovery energy	E_{rec}	V_{CC} = 900 V, I_F = 225 A, V_{GE} = -15 V, -di$_F$/dt = 3100 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		32.5		mJ
			T_{vj} = 125 °C		60.5		
			T_{vj} = 150 °C		69		
Thermal resistance, junction to case	R_{thJC}	per diode				0.16	K/W
Thermal resistance, case to heat sink	R_{thCH}	per diode, λ_{grease} = 1 W/(m·K)			0.047		K/W
Temperature under switching conditions	$T_{vj\,op}$			-40		150	°C

4 NTC-Thermistor

Table 7 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	T_{NTC} = 25 °C		5		kΩ
Deviation of R_{100}	$\Delta R/R$	T_{NTC} = 100 °C, R_{100} = 493 Ω	-5		5	%
Power dissipation	P_{25}	T_{NTC} = 25 °C			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2-1/(298{,}15\ K))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2-1/(298{,}15\ K))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2-1/(298{,}15\ K))]$		3433		K

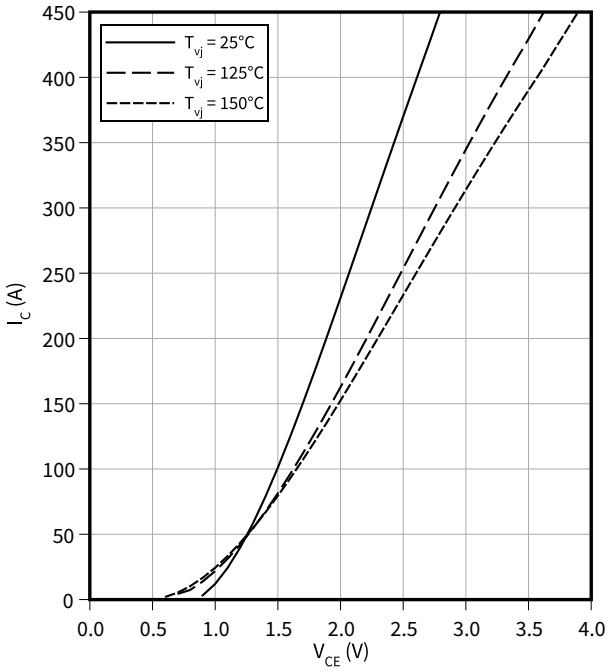
***Note**: For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4*

5 Characteristics diagrams

Output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$

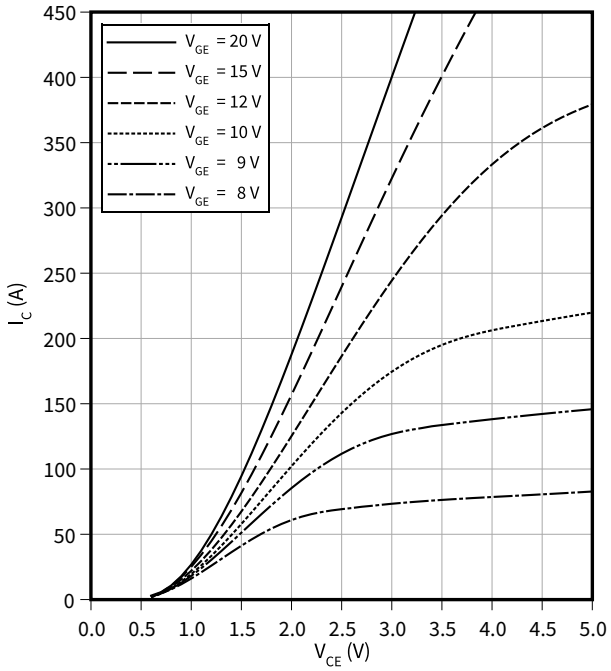
$V_{GE} = 15$ V



Output characteristic field (typical), IGBT, Inverter

$I_C = f(V_{CE})$

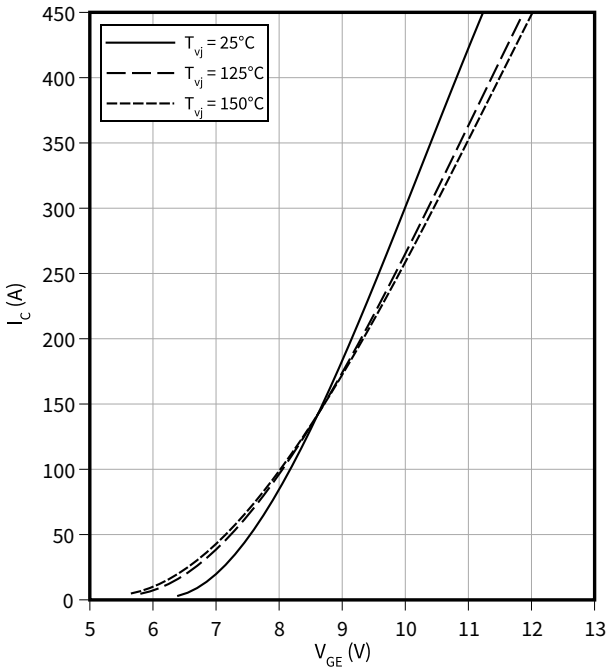
$T_{vj} = 150$ °C



Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$

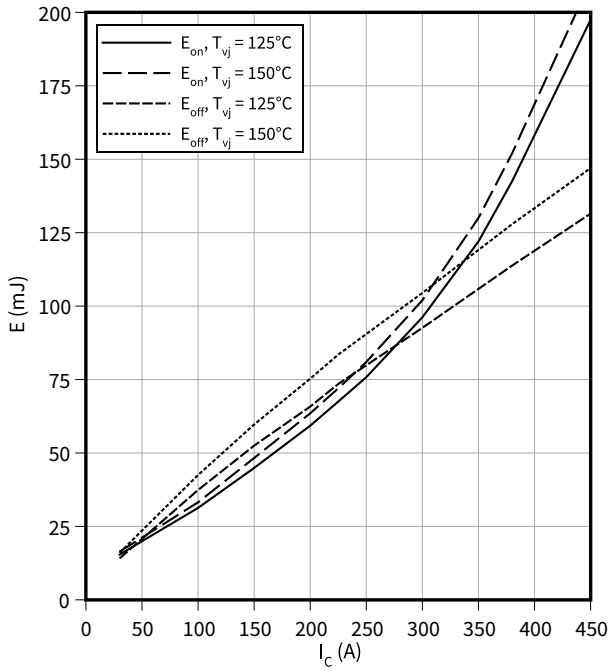
$V_{CE} = 20$ V



Switching losses (typical), IGBT, Inverter

$E = f(I_C)$

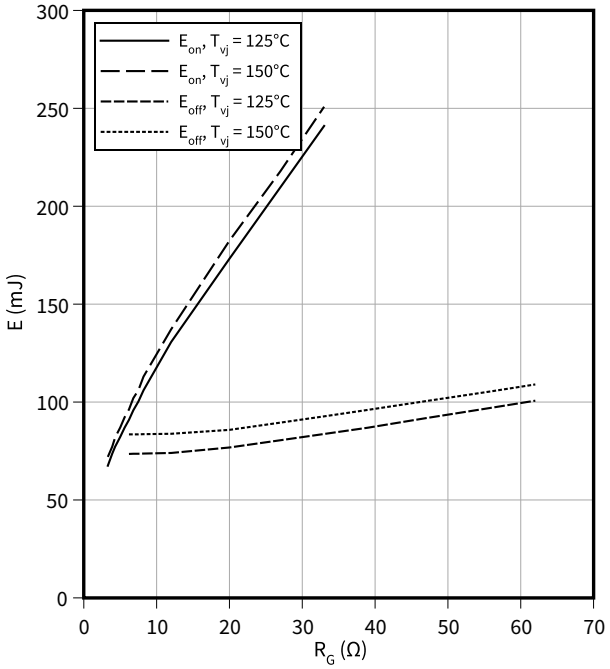
$R_{Goff} = 6.2\ \Omega$, $R_{Gon} = 3.3\ \Omega$, $V_{GE} = \pm 15$ V, $V_{CC} = 900$ V



Switching losses (typical), IGBT, Inverter

$E = f(R_G)$

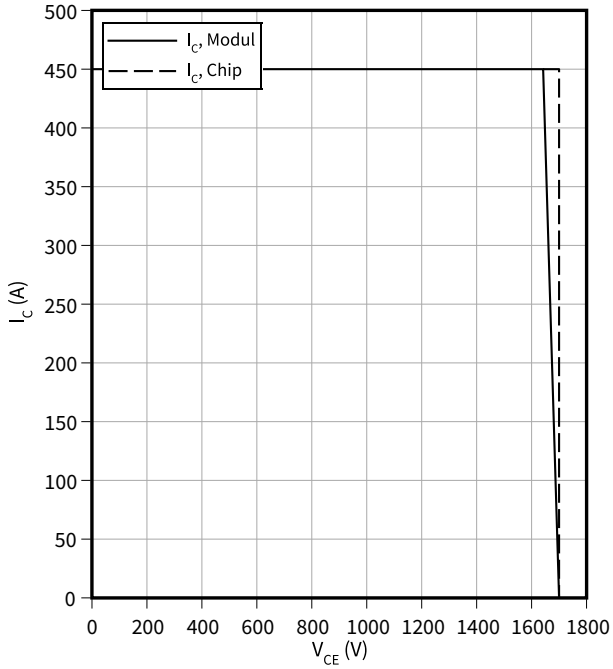
$V_{GE} = \pm 15$ V, $I_C = 225$ A, $V_{CC} = 900$ V



Reverse bias safe operating area (RBSOA), IGBT, Inverter

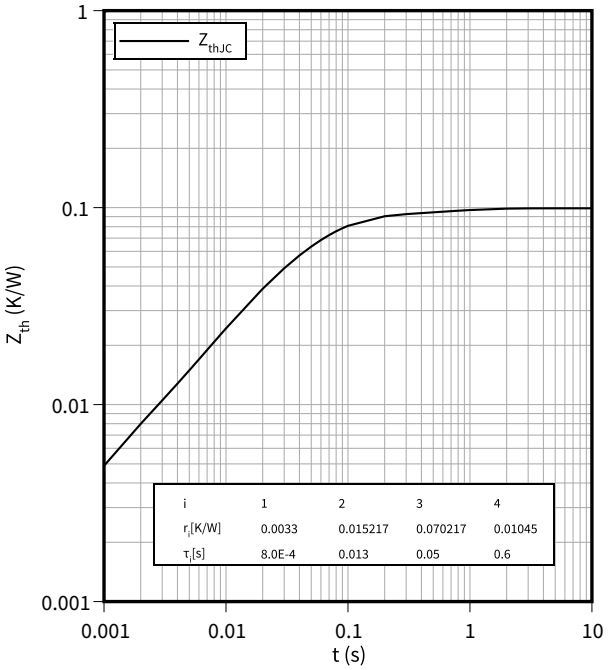
$I_C = f(V_{CE})$

$R_{Goff} = 6.2\ \Omega$, $V_{GE} = \pm 15$ V, $T_{vj} = 150$ °C



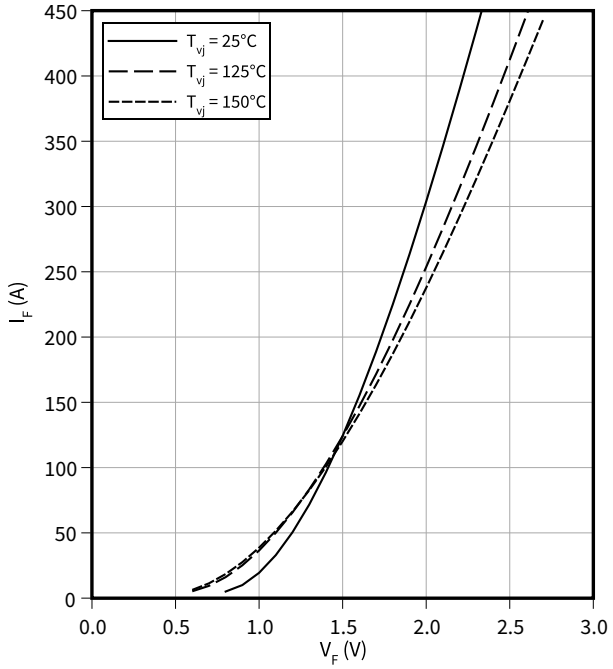
Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Inverter

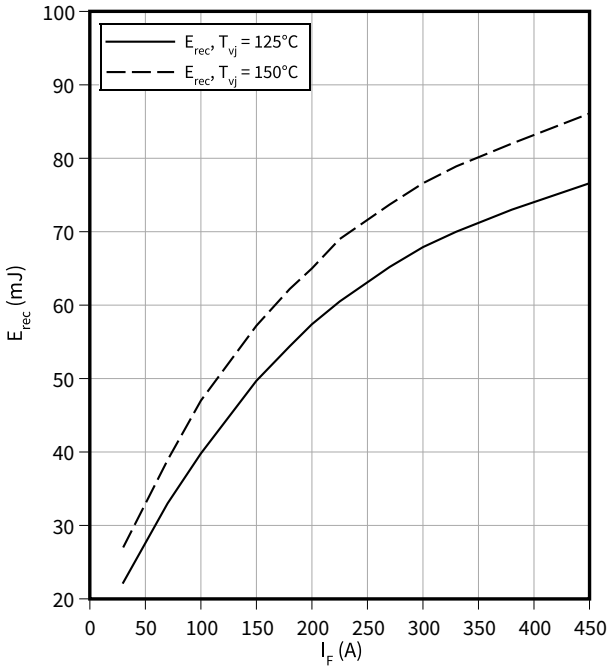
$I_F = f(V_F)$



Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$

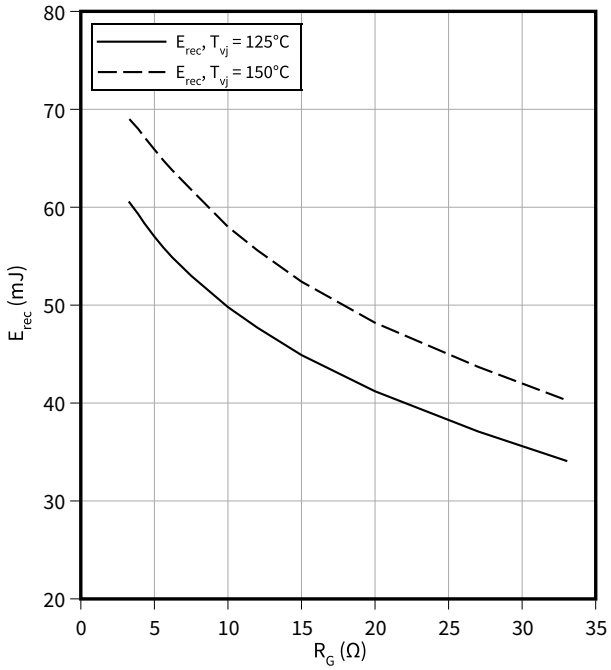
$R_{Gon} = 3.3\ \Omega$, $V_{CE} = 900\ V$



Switching losses (typical), Diode, Inverter

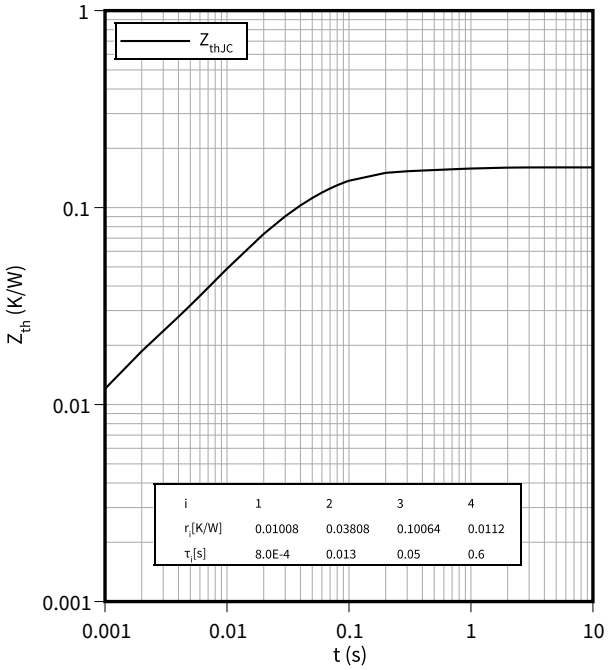
$E_{rec} = f(R_G)$

$V_{CE} = 900\ V$, $I_F = 225\ A$



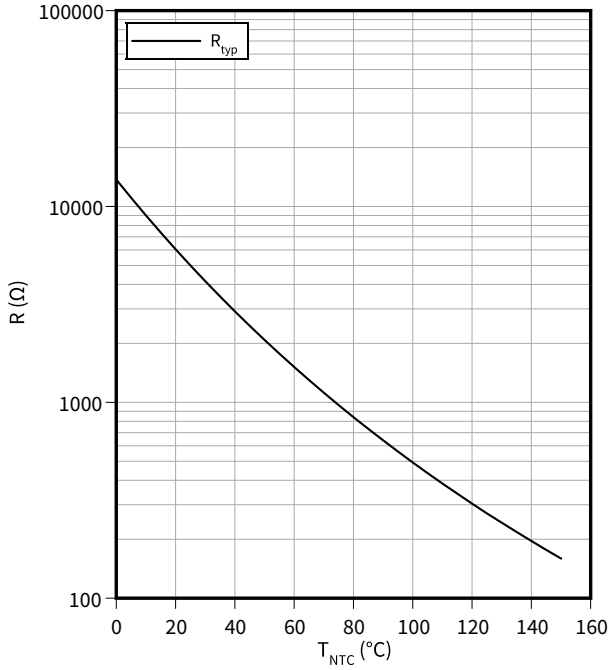
Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

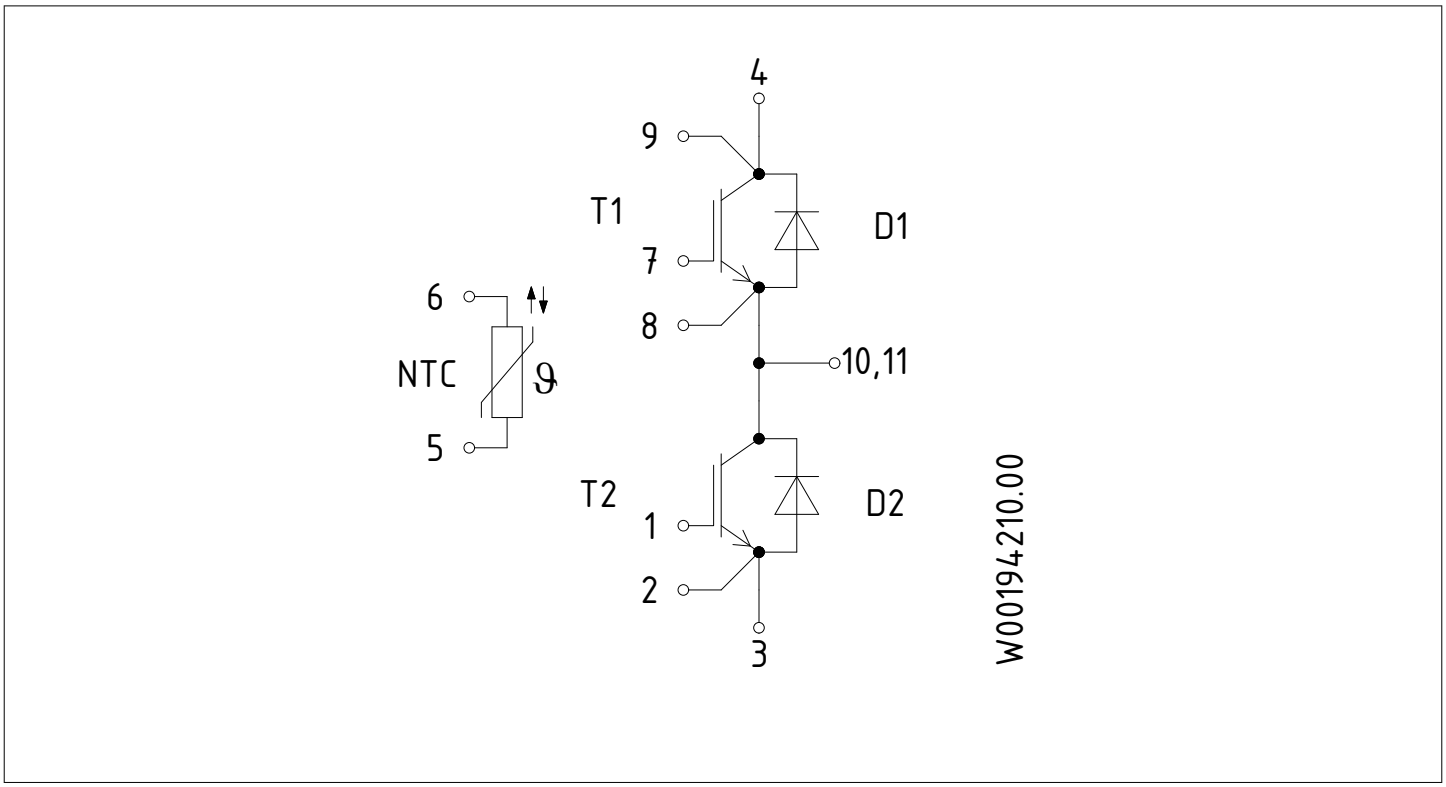


Figure 1

7 Package outlines

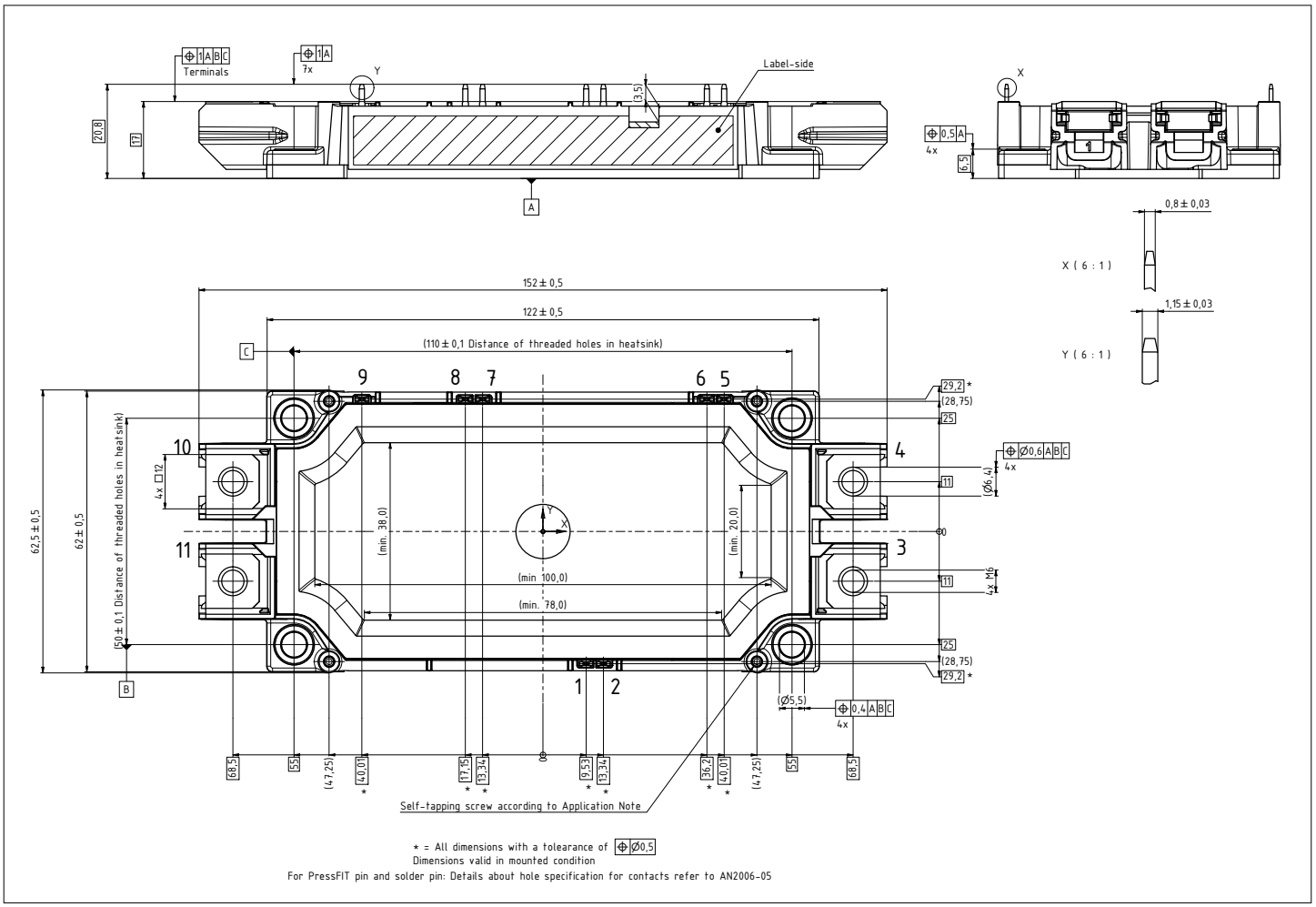


Figure 2

8 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	*Content* Module serial number Module material number Production order number Date code (production year) Date code (production week)	*Digit* 1 – 5 6 - 11 12 - 19 20 – 21 22 – 23	*Example* 71549 142846 55054991 15 30
Example	7154914284655054991530		7154914284655054991530

Figure 3

Revision history

Document revision	Date of release	Description of changes
V1.0	2007-12-12	Target datasheet
V2.0	2008-12-09	Preliminary datasheet
V2.1	2009-01-05	Preliminary datasheet
V2.2	2010-11-04	Preliminary datasheet
V2.3	2011-03-01	Preliminary datasheet
V2.4	2014-06-06	Preliminary datasheet
V3.0	2018-11-15	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2025-10-17	Final datasheet

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